

REV B Changes:

R11 was removed from the PWN, TGEN, CTRL and VREF pins TVS was added to VIN VIN was changed to Through Hole, no more pads for daisy chaining Sync test point removed Logo Added New Inductor replaces old one 4 Layer Board, Inner layers are GND Added RC circuit to VIN

General Notes:

OUT have has an 18AWG test point. This won't look larger than a small via, but may be useful

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